



Important Information/Disclaimer

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Package: PDIP 8 ROHS	*****Composition*****				
	Name	Wt% (composition in each item)	Weight (milli- grams)	Fraction of Total Pkg Weight %	ppm
	<i>(user input)</i>	<i>(user input)</i>	<i>(calc)</i>	<i>(calc)</i>	<i>(calc)</i>
Die	Silicon (Si)	100	2.000	0.370%	3,702
Die Attach	Silver (Ag)	74	1.258	0.233%	2,329
	Resin	26	0.442	0.082%	818
Frame Material	Copper (Cu)	97	149.865	27.743%	277,425
	Iron (Fe)	3	4.635	0.858%	8,580
Bond Wire	Gold (Au)	100	1.000	0.185%	1,851
Mold Compound	Resin	88	299.200	55.387%	553,869
	Filler (SiO2)	12	40.800	7.553%	75,528
Lead Finish	Tin (Sn)	100	41.000	7.5898%	75,898
<--total weight (milligrams)-->			540.200	100.0%	1,000,000